

AEC Electronics Company Limited PRODUCT SPECIFICATION

CERAMIC RESONATOR

AEC PART NUMBER / SPEC. NO: ZTTCP8.00MG

CUSTOMER:



Peak soldering temperature 260°C/10 sec

Ceramic component is exempted (According to ROHS directive 2005/95/EC ANNEX point 7)

Customer's Name	
Production Name	Ceramic Resonator
Frequency	8.00MHz
Model No	ZTTCP8.00MG
Issue Date	23 rd April, 2020

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Prepared	Inspection	Approved
	Andy	Henkie

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1. SCOPE

This specification shall cover the characteristics of the ceramic resonator with the type ZTTCP8.00MG

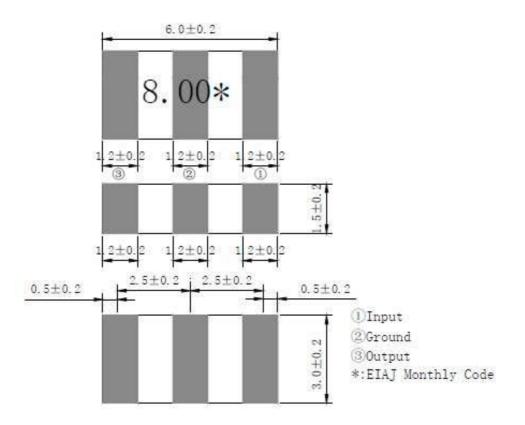
2. PART NO.:

PART NUMBER	CUSTOMER PART NO	SPECIFICATION NO
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3. OUTLINE DRAWING AND DIMENSIONS:

3.1 Appearance: No visible damage and dirt.

3.2 Dimensions:



Unit: mm

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4. ELECTRICAL SPECIFICATIONS:

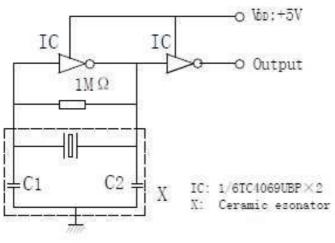
		Requirements		
4.1	Oscillation Frequency Fosc	8.00		
	(M(Hz)) Frequency Accuracy (%)	±0.5		
4.2	Resonant Impedance Ro (ΩΩmax	30		
4.3	Temperature Coefficient of	±0±3 (Oscillation		
	Oscillation Frequency (%) max	Frequency drift -20°C°		
		+80°C) ℃		
4.4	Withstanding Voltage	100 VDC, 5 sec		
4.5	Rating Voltage U _R (V)			
	(1) D.C. Voltage	6 VDC.		
	(2) A.C. Voltage	15 Vp-p.		
4.6	Insulation Resistance Ri, $(M\Omega\Omega)$ min	500 (10V, 1min)		
4.7	Operating Temperature (°C)°C	-20 ~ +80		
4.8	Storage Temperature (C)°C	-55 ~ +85		
4.9	Aging Rate (%) max	±0±1 From initial value		

Components shall be left in a chamber of +85 $\pm 2^{\circ}$ C for 1000 hours, then measured after leaving

in natural condition for 1 hours.

5. MEASUREMENT:

- 5.1 Measurement Conditions: Parts shall be measured under a condition (Temp: : 20±15°C,Humidity : 65±20% R.H.) unless the standard condition (Temp.: 25±3 °C,Humidity : 65±5% R.H.) is regulated to measure.
- 5.2 Test Circuit:



C1=C2 = 30pF

6 PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

No	Item	Condition of Test		
				Requirements
6.1	Humidity	Keep the resonator at 40±2°C°	It shall fulfill the	
		90-95% RH for 96±4 hours. The	specifications in	
		the resonator into the room Co	ondition	Table 1.
		for 1 hour prior to the Measure	ement.	
6.2	Vibration	Subject the resonator to vibrat	tion for 2	It shall fulfill the
		hours each in x_y and z axis	With the	specifications in
		amplitude of 1.5mm, the freque	ency shall	Table 1.
		be varied uniformly between t	he limits of	
		10 Hz—55Hz.		
6.3	Mechanical	Drop the resonator randomly o	onto a	It shall fulfill the
	Shock	wooden floor from the height o	of 100cm 3	specifications in
		times.		Table 1.
6.4	Soldering	Passed through the re-flow ov	en under	It shall fulfill the
	Test	the following condition and lef	ft at room	specifications in
		temperature for 1 hour before		Table 1.
		measurement.		
		Temperature at the surface of	Time	
		the substrate		
		Preheat 150±5°C°C	60±10	
			sec	
		Peak 260±5℃°C	10±3 sec	
6.5	Solder	Dipped in 250±5°C°€older bath	n for 3±0.5	The terminals shall
	Ability	sec seconds with rosin flux (2	5wt%	be at least 95%
		ethanol solution.)		covered by solder.
6.6	High	Subject the resonator to 80±5°	°C°for 96	It shall fulfill the
	Temperature	hours, then release the resona	ator into	specifications in
	Exposure	the room conditions for 1 hour	r prior to	Table 1.
		the measurement.		
6.7	Low	Subject the resonator to -20±5	°C°for 96	It shall fulfill the
	Temperature	hours, then release the resona	ator into	specifications in
	Exposure	the room conditions for 1 hour the measurement.	Table 1.	

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	ltem	Condition of Test	
			Requirements
6.8	Temperature	Subject the resonator to -40°C°for 30	It shall fulfill the
	Cycling	min. followed by a high temperature of	specifications in
		85℃°@r 30 min.	Table 1.
		Cycling shall be repeated 5 times with a	
		transfer time of 15 sec. At the room	
		temperature for 1 hour prior to the	
		measurement.	
6.9	Board	Mount a glass-epoxy board	Mechanical
	Bending	(Width=40mm,thickness=1.6mm),then	damage such as
		bend it to 1mm displacement and keep it	breaks shall not
		for 5 seconds. (See the following figure)	occur.
		PRESS HEAD D.U.T. 45±2 05 SUPPORT BAR	

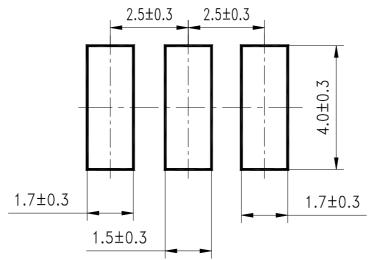
TABLE 1

ltem	Specification
Oscillation Frequency Change	±0.3
<u>Ʈ</u> osc/Fosc (%) max	
Resonant Impedance Ro(ΩΩmax	35

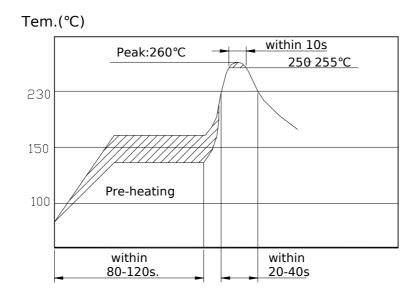
Note: The limits in the above table are referenced to the initial measurements.

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7.1Recommended land pattern



7.2 Recommended reflow soldering standard conditions



8 PACKAGE

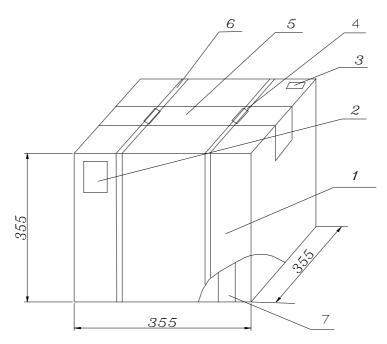
To protect the products in storage and transportation , it is necessary to pack them

(outer and inner package). On paper pack, the following requirements are requested.

8.1 Dimensions and Mark

At the end of package, the warning (moisture proof, upward put) should be stick to it.

Dimensions and Mark (see below)



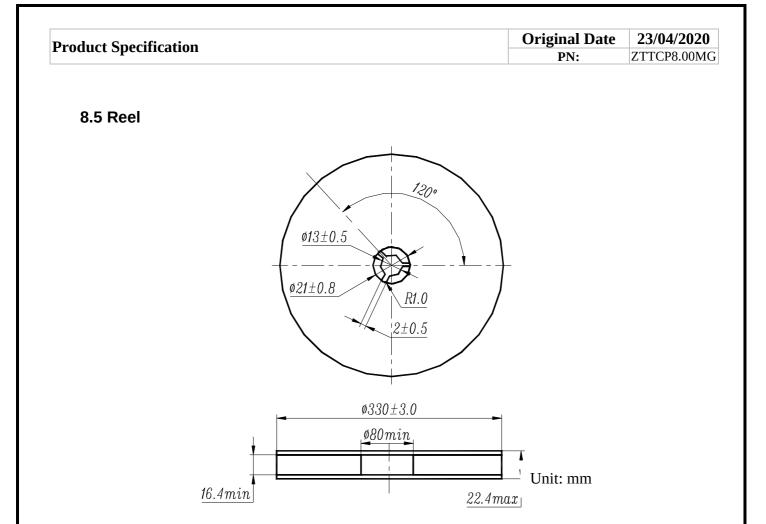
NO.	Name	Quantity	Notes
1	Package	1	
2	Certificate of approval	1	
3	Label	1	
4	Tying	2	
5	Adhesive tape	1.2m	
6	Belt	2.9m	
7	Inner Box	10	

8.2 Section of package

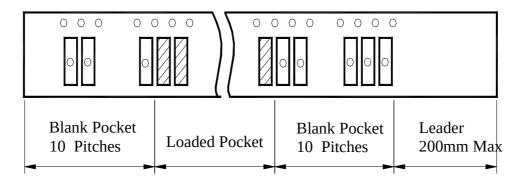
Package is made of corrugated paper with thickness of 0.8cm. Package has 10 inner boxes, each box has 1 reel (each reel for plastic bag).

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8.3 Quantity of package				
Per plastic reel	4000	pieces of piezoelect	ric ceramic part	
Per inner box	1 re	el		
Per package	10 iı	nner boxes(40000 pie	eces of piezoel	lectric
	ceramic	part))		
8.4 Inner Packing Dimens	sions			
	340±2		1.UNIT: mm	
	1	Label		
	2	QC Label		
	3	Inner Box		

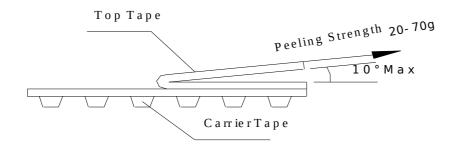
Pars shall be packaged in box with hold down tape upside. Part No., quantity and lot No.



8.6 Packing Method Sketch Map



8.7 Test Condition Of Peeling Strength



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9. EIAJ Monthly Code

2019/2021	2019/2021/2023/2025		/2022/2024
MONTH	CODE	MONTH	CODE
JAN	А	JAN	Ν
FEB	В	FEB	Р
MAR	С	MAR	Q
APR	D	APR	R
MAY	E	MAY	S
JUN	F	JUN	Т
JUL	G	JUL	U
AUG	Н	AUG	V
SEP	J	SEP	W
ОСТ	K	OCT	Х
NOV	L	NOV	Y
DEC	М	DEC	Z

10 OTHER

10.1 Caution

10.1.1 Don't apply excess mechanical stress to the component and terminals at soldering. Do not use this product with bend.

10.1.2 Do not clean or wash the component for it is not hermetically sealed.

10.1.3 Do not use strong acidity flux, more than 0.2wt% chlorine content, in flow soldering.

10.1.4 Don't be close to fire.

10.1.5 This specification mentions the quality of the component as a single unit. Please insure the component is thoroughly evaluated in your application circuit

10.1.6 Expire date (Shelf life) of the products is 12 months after delivery under the conditions of a sealed and an unopened package. Please use the products within 12 months after delivery. If you store the products for a long time (more than 12 months), use carefully because the products may be degraded in the solderability or rusty. Please confirm solderability and characteristics for the products regularly.

10.2 Notice

10.2.1 Please return one of this specification after your signature of acceptance.

10.2.2 When something gets doubtful with this specifications, we shall jointly work to get an agreement.